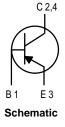
# **Bipolar Power Transistors**

## **PNP Silicon**

- Collector –Emitter Sustaining Voltage V<sub>CEO(sus)</sub>
   30 Vdc (Min) @ I<sub>C</sub> = 10 mAdc
- High DC Current Gain hFE
  - = 125 (Min) @ I<sub>C</sub> = 0.8 Adc
  - = 90 (Min) @ IC = 3.0 Adc
- Low Collector –Emitter Saturation Voltage V<sub>CE(sat)</sub>
   = 0.275 Vdc (Max) @ I<sub>C</sub> = 1.2 Adc
  - = 0.55 Vdc (Max) @ I<sub>C</sub> = 3.0 Adc
- SOT–223 Surface Mount Packaging



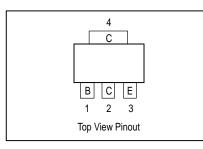
## **MMJT9435**

Motorola Preferred Device

POWER BJT
IC = 3.0 AMPERES
BVCEO = 30 VOLTS
VCE(sat) = 0.275 VOLTS



CASE 318E-04, Style 1



### **MAXIMUM RATINGS** (T<sub>C</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCEO	30	Vdc
Collector–Base Voltage	V <sub>CB</sub>	45	Vdc
Emitter–Base Voltage	VEB	±6.0	Vdc
Base Current — Continuous	lΒ	1.0	Adc
Collector Current — Continuous — Peak	IC	3.0 5.0	Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C  Derate above 25°C  Total P <sub>D</sub> @ T <sub>A</sub> = 25°C mounted on 1" sq. (645 sq. mm) Collector pad on FR–4 bd material  Total P <sub>D</sub> @ T <sub>A</sub> = 25°C mounted on 0.012" sq. (7.6 sq. mm) Collector pad on FR–4 bd material	PD	3.0 24 1.56 0.72	Watts mW/°C Watts
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance – Junction to Case  – Junction to Ambient on 1" sq. (645 sq. mm) Collector pad on FR–4 bd material  – Junction to Ambient on 0.012" sq. (7.6 sq. mm) Collector pad on FR–4 bd material	R <sub>θ</sub> JC R <sub>θ</sub> JA R <sub>θ</sub> JA	42 80 174	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C

This document contains information on a new product. Specifications and information are subject to change without notice.

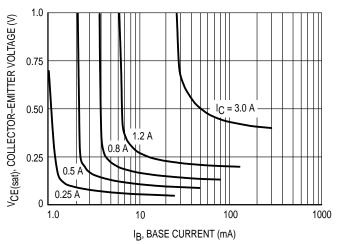
Preferred devices are Motorola recommended choices for future use and best overall value.

### **MMJT9435**

## **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•	•	•		
Collector–Emitter Sustaining Voltage (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 0 Adc)	VCEO(sus)	30	_	_	Vdc
Emitter–Base Voltage (I <sub>E</sub> = 50 μAdc, I <sub>C</sub> = 0 Adc)	V <sub>EBO</sub>	6.0	_	_	Vdc
Collector Cutoff Current (V <sub>CE</sub> = 25 Vdc, R <sub>BE</sub> = 200 $\Omega$ ) (V <sub>CE</sub> = 25 Vdc, R <sub>BE</sub> = 200 $\Omega$ , T <sub>J</sub> = 125°C)	lCER	_	_	20 200	μAdc
Emitter Cutoff Current (VBE = 5.0 Vdc)	I <sub>EBO</sub>	_	_	10	μAdc
ON CHARACTERISTICS <sup>(1)</sup>	•				
Collector–Emitter Saturation Voltage (IC = 0.8 Adc, IB = 20 mAdc) (IC = 1.2 Adc, IB = 20 mAdc) (IC = 3.0 Adc, IB = 0.3 Adc)	VCE(sat)	_ _ _	0.155 — —	0.210 0.275 0.550	Vdc
Base–Emitter Saturation Voltage (IC = 3.0 Adc, I <sub>B</sub> = 0.3 Adc)	VBE(sat)	_	_	1.25	Vdc
Base–Emitter On Voltage (I <sub>C</sub> = 1.2 Adc, V <sub>CE</sub> = 4.0 Vdc)	VBE(on)	_	_	1.10	Vdc
DC Current Gain (I <sub>C</sub> = 0.8 Adc, V <sub>CE</sub> = 1.0 Vdc) (I <sub>C</sub> = 1.2 Adc, V <sub>CE</sub> = 1.0 Vdc) (I <sub>C</sub> = 3.0 Adc, V <sub>CE</sub> = 1.0 Vdc)	hFE	125 110 90	220 — —	_ _ _	_
DYNAMIC CHARACTERISTICS	•				
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0 Adc, f = 1.0 MHz)	C <sub>ob</sub>	_	100	150	pF
Input Capacitance (VEB = 8.0 Vdc)	C <sub>ib</sub>	_	135	_	pF
Current–Gain — Bandwidth Product(2) (IC = 500 mA, V <sub>CE</sub> = 10 V, F <sub>test</sub> = 1.0 MHz)	f⊤	_	110	_	MHz

<sup>(1)</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%. (2) f<sub>T</sub> = |h<sub>FE</sub>| • f<sub>test</sub>



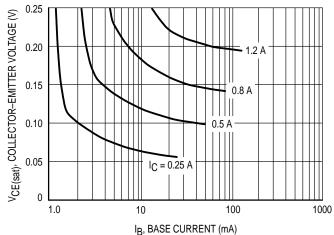
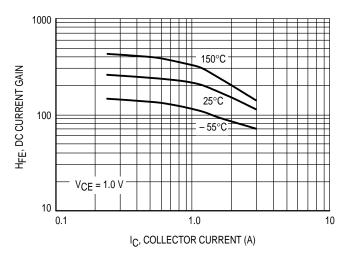


Figure 1. Collector Saturation Region

Figure 2. Collector Saturation Region



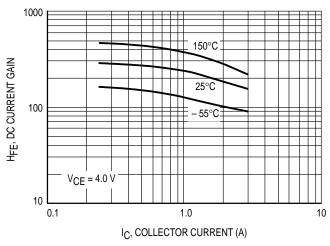
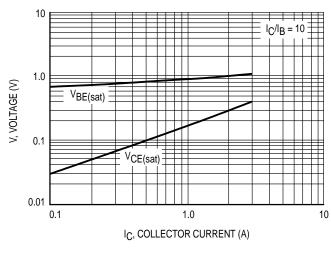


Figure 3. DC Current Gain

Figure 4. DC Current Gain



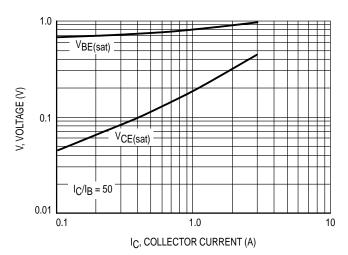


Figure 5. "On" Voltages

Figure 6. "On" Voltages

#### **MMJT9435**

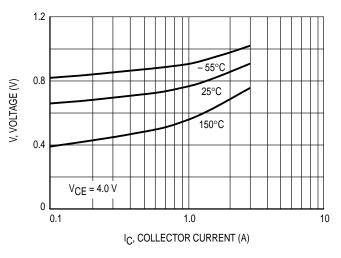


Figure 7. VBE(on) Voltage

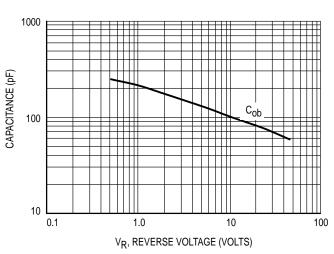


Figure 8. Output Capacitance

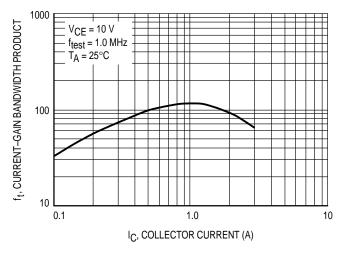


Figure 9. Current-Gain Bandwidth Product

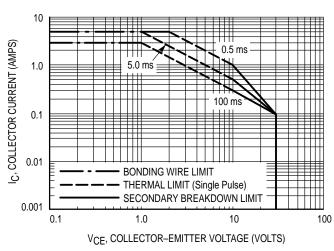


Figure 10. Active Region Safe Operating Area

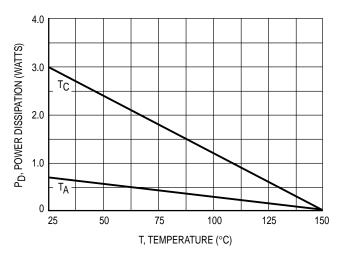


Figure 11. Power Derating

There are two limitations on the power handling ability of a transistor: average junction temperature and secondary breakdown. Safe operating area curves indicate IC – VCE limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 10 is based on  $T_{J(pk)} = 150^{\circ}C$ ;  $T_{C}$  is variable depending on conditions. Secondary breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \le 150^{\circ}C$ .  $T_{J(pk)}$  may be calculated from the data in Figure 12. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by secondary breakdown.

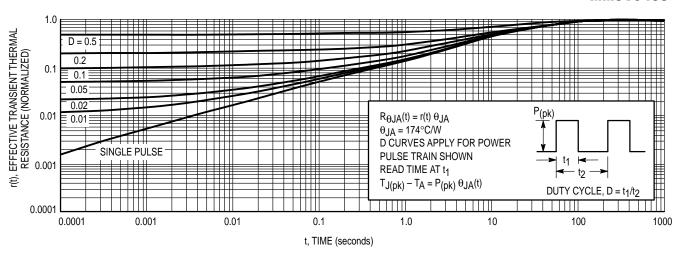
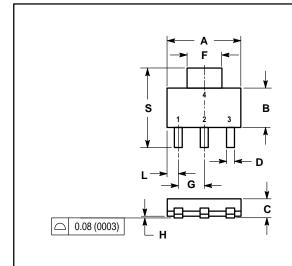


Figure 12. Thermal Response

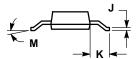
#### PACKAGE DIMENSIONS



PIN 1. BASE 2 COLLECTOR

STYLE 1:

3. EMITTER
4. COLLECTOR



CASE 318E-04 ISSUE H

#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   ALL EM 1092
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

DON'T NOLLING DIMENSION. INOT.					
	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.249	0.263	6.30	6.70	
В	0.130	0.145	3.30	3.70	
С	0.060	0.068	1.50	1.75	
D	0.024	0.035	0.60	0.89	
F	0.115	0.126	2.90	3.20	
G	0.087	0.094	2.20	2.40	
Н	0.0008	0.0040	0.020	0.100	
J	0.009	0.014	0.24	0.35	
K	0.060	0.078	1.50	2.00	
L	0.033	0.041	0.85	1.05	
M	0°	10 °	0 °	10 °	
S	0.264	0.287	6.70	7.30	

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